



FXL2T245

Low-Voltage, Dual-Supply, 2-Bit, Signal Translator with Configurable Voltage Supplies and Signal Levels and 3-State Outputs

Features

- Bi-Directional Interface between any 2 Levels from 1.1 V to 3.6 V
- Fully Configurable, Inputs Track V_{CC} Level
- Non-Preferential Power-up Sequencing; either V_{CC} maybe Powered-up First
- Outputs Remain in 3-State until Active V_{CC} Level is Reached
- Outputs Switch to 3-State if either V_{CC} is at GND
- Power-Off Protection
- Control Inputs (T/R, OE) Levels are Referenced to V_{CCA} Voltage
- Packaged in 10-Lead MicroPak (1.6 mm x 2.1 mm) Package
- ESD Protection Exceeds:
 - 4 kV HBM ESD JESD22-A114 & Mil Std 883e 3015.7)
 - 8kV HBM I/O to GND ESD (per JESD22-A114 & Mil Std 883e 3015.7)
 - 1 kV CDM ESD (per ESD STM 5.3)
 - 200 V MM ESD (per JESD22-A115 & ESD STM5.2)

Description

The FXL2T245 is a configurable, dual-voltage-supply translator designed for uni-directional and bi-directional voltage translation between two logic levels. The device allows translation between voltages as high as 3.6 V to as low as 1.1 V. The A port tracks the V_{CCA} level and the B port tracks the V_{CCB} level. This allows for bi-directional voltage translation over a variety of voltage levels: 1.2 V, 1.5 V, 1.8 V, 2.5 V, and 3.3 V.

The device remains in 3-state until both V_{CC} s reach active levels, allowing either V_{CC} to be powered-up first. Internal power-down control circuits place the device in 3-state if either V_{CC} is removed.

The Transmit / Receive (T/R) input determines the direction of data flow through the device. The OE input, when HIGH, disables both the A and B ports by placing them in a 3-state condition. The FXL2T245 is designed so control pins T/R and OE are supplied by V_{CCA} .

Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FXL2T245L10X	-40°C to +85°C	10-Lead, MicroPak™, JEDEC MO255, 1.6 x 2.1 mm	Tape and Reel

Pin Configuration

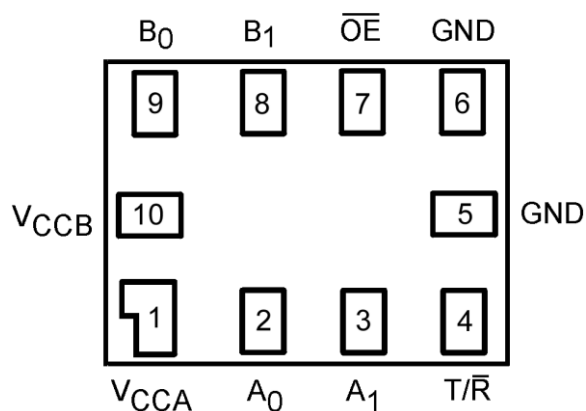


Figure 1. Pin Assignments

Pin Descriptions

Pin#	Pin Name	Description
1	V_{CCA}	Side A Power Supply
2	A_0	Side A Inputs or 3-State Outputs
3	A_1	Side A Inputs or 3-State Outputs
4	$T/\bar{R}$	Transmit/Receive Input
5, 6	GND	Ground
7	$\overline{OE}$	Output Enable Input
8	B_1	Side B Inputs or 3- State Outputs
9	B_0	Side B Inputs or 3-State Outputs
10	V_{CCB}	Side B Power Supply

Truth Table

Inputs		Outputs
$\overline{OE}$	$T/\bar{R}$	
LOW	LOW	Bus B Data to Bus A
LOW	HIGH	Bus A Data to Bus B

Notes:

1. LOW = low voltage level.
2. HIGH = high voltage level.

Functional Description

Power-Up / Power-Down Sequencing

Due to the chip design, the FXL2T245 translator offers the advantage of either V_{CC} being powered up first. When either V_{CC} is at 0 V, outputs are in a high-impedance state. The control inputs ($\overline{T/R}$ and $\overline{OE}$) are designed to track the V_{CCA} supply. A pull-up resistor tying $\overline{OE}$ to V_{CCA} should be used to ensure that bus contention, excessive currents, or oscillations do not occur during power-up/power-down. The size of the pull-up resistor is based upon the current-sinking capability of the OE driver.

The recommended power-up sequence is:

1. Apply power to either V_{CC} .
2. Apply power to the $\overline{T/R}$ input (logic HIGH for A-to-B operation; logic LOW for B-to-A operation) and to the respective data inputs (A port or B port). This may occur at the same time as step 1.
3. Apply power to the other V_{CC} .
4. Drive the $\overline{OE}$ input LOW to enable the device.

The recommended power-down sequence is:

1. Drive $\overline{OE}$ input HIGH to disable the device.
2. Remove power from either V_{CC} .
3. Remove power from the other V_{CC} .

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Conditions	Min.	Max.	Unit
V_{CCA}	Supply Voltage		-0.5	4.6	V
V_{CCB}			-0.5	4.6	
V_I	DC Input Voltage	I/O Port A	-0.5	4.6	V
		I/O Port B	-0.5	4.6	
		Control Inputs ($\overline{T/R}$, $\overline{OE}$)	-0.5	4.6	
V_O	Output Voltage ⁽³⁾	Output 3-State	-0.5	4.6	V
		Output Active (A_n)	-0.5 to V_{CCA}	0.5	
		Output Active (B_n)	-0.5 to V_{CCB}	0.5	
I_{IK}	DC Input Diode Current	$V_I < 0$ V		-50	mA
I_{OK}	DC Output Diode Current	$V_O < 0$ V		-50	mA
		$V_O > V_{CC}$		+50	
I_{OH}/I_{OL}	DC Output Source/Sink Current			±50	mA
I_{CC}	DC V_{CC} or Ground Current per Supply Pin			±100	mA
T_{STG}	Storage Temperature Range		-65	+150	°C
ESD	Electrostatic Discharge Capability	Human Body Model, JESD22-A114, Mil Std 883e 3015.7	All Pins	4	kV
			I/O to GND	8	
		Charged Device Model, JESD22-C101, STM 5.3		1	V
		Machine Model, JESD22-A115, STM 5.2		200	

Note:

3. I/O absolute maximum ratings must be observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions		Min.	Max.	Unit
V _{CC}	Power Supply	Operating V _{CCA} or V _{CCB}		1.1	3.6	V
V _I	Input Voltage	Port A		0	3.6	V
		Port B		0	3.6	
		Control Inputs (T/R, OE)		0	V _{CCA}	
I _{OH} /I _{OL}	Output Current	V _{CC}	3.0 V to 3.6 V		±24	mA
			2.3 V to 2.7 V		±18	
			1.65 V to 1.95 V		±6	
			1.40 V to 1.65 V		±2	
			1.1 V to 1.4 V		±0.5	
T _A	Operating Temperature, Free Air			-40	+85	°C
ΔV/Δt	Minimum Input Edge Rate	V _{CCA/B} =1.1 V to 3.6 V			10	ns/V

Note:

4. All unused inputs must be held at V_{CCI} or GND.

Electrical Characteristics

Symbol	Parameter	Conditions	V _{CC0} (V)	V _{CCI} (V)	Min.	Max.	Unit
V _{IH}	HIGH Level Input ⁽⁵⁾	Data Inputs A _n , B _n	1.10 to 3.60	2.70 to 3.60	2.00		V
				2.30 to 2.70	1.60		
				1.65 to 2.30	0.65 x V _{CCI}		
				1.40 to 1.65	0.65 x V _{CCI}		
				1.10 to 1.40	0.90 x V _{CCI}		
		Control Pins $\overline{\text{OE}}$, $\overline{\text{T/R}}$ (Referenced to V _{CCA})		2.70 to 3.60	2.00		
				2.30 to 2.70	1.60		
				1.65 to 2.30	0.65 x V _{CCA}		
				1.40 to 1.65	0.65 x V _{CCA}		
				1.10 to 1.40	0.90 x V _{CCA}		
V _{IL}	LOW Level Input ⁽⁵⁾	Data Inputs A _n , B _n	1.10 to 3.60	2.70 to 3.60		0.80	V
				2.30 to 2.70		0.70	
				1.65 to 2.30		0.35 x V _{CCI}	
				1.40 to 1.65		0.35 x V _{CCI}	
				1.10 to 1.40		0.10 x V _{CCI}	
		Control Pins $\overline{\text{OE}}$, $\overline{\text{T/R}}$ (Referenced to V _{CCA})		2.70 to 3.60		0.80	
				2.30 to 2.70		0.70	
				1.65 to 2.30		0.35 x V _{CCI}	
				1.40 to 1.65		0.35 x V _{CCI}	
				1.10 to 1.40		0.10 x V _{CCI}	
V _{OH}	HIGH Level Output ⁽⁶⁾	I _{OH} = -100 μA	1.10 to 3.60	1.10 to 3.60	V _{CC0} - 0.20		V
		I _{OH} = -12 mA	2.70	2.70	2.20		
		I _{OH} = -18 mA	3.00	3.00	2.40		
		I _{OH} = -24 mA	3.00	3.00	2.20		
		I _{OH} = -6 mA	2.30	2.30	2.00		
		I _{OH} = -12 mA	2.30	2.30	1.80		
		I _{OH} = -18 mA	2.30	2.30	1.70		
		I _{OH} = -6 mA	1.65	1.65	1.25		
		I _{OH} = -2 mA	1.40	1.40	1.05		
		I _{OH} = -0.5 mA	1.10	1.10	0.75 x V _{CC0}		
V _{OL}	LOW Level Output ⁽⁶⁾	I _{OL} = 100 μA	1.10 to 3.60	1.10 to 3.60		0.20	V
		I _{OL} = 12 mA	2.70	2.70		0.40	
		I _{OL} = 18 mA	3.00	3.00		0.40	
		I _{OL} = 24 mA	3.00	3.00		0.55	
		I _{OL} = 12 mA	2.30	2.30		0.40	
		I _{OL} = 18 mA	2.30	2.30		0.60	
		I _{OL} = 6 mA	1.65	1.65		0.30	
		I _{OL} = 2 mA	1.40	1.40		0.35	
		I _{OL} = 0.5 mA	1.10	1.10		0.30 x V _{CC0}	

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Electrical Characteristics

Symbol	Parameter	Conditions	V _{CCO} (V)	V _{CCI} (V)	Min.	Max.	Unit
I _L	Input Leakage Current, Control Pins	V _I =V _{CCA} or GND	3.60	1.10 to 3.60		±1.0	μA
I _{OFF}	Power Off Leakage Current	A _n , V _I or V _O =0 V to 3.6 V	3.60	0		±10	μA
		B _n , V _I or V _O =0 V to 3.6 V	0	3.60		±10	
I _{OZ}	3-State Output Leakage (0 ≤ V _O ≤ 3.6 V, V _I =V _{IH} or V _{IL})	A _n , B _n , /OE=V _{IH}	3.60	3.60		±10	μA
		B _n , /OE= Don't Care ⁽⁷⁾	3.60	0		±10	
		A _n , /OE= Don't Care ⁽⁷⁾	0	3.60		±10	
I _{CCA/B}	Quiescent Supply Current ⁽⁸⁾	V _I =V _{CCI} or GND; I _O =0	1.10 to 3.60	1.10 to 3.60		20	μA
I _{CCZ}			1.10 to 3.60	1.10 to 3.60		20	
I _{CCA}		V _I =V _{CCA} or GND; I _O =0	1.10 to 3.60	0		-10	
			0	1.10 to 3.60		10	
I _{CCB}		V _I =V _{CCB} or GND; I _O =0	0	1.10 to 3.60		-10	
			1.10 to 3.60	0		10	
ΔI _{CCA/B}	Increase in I _{CC} per Input; Other Inputs at V _{CC} or GND	V _{IH} =3.0 V	3.60	3.60		500	μA

Notes:

5. V_{CCI} = the V_{CC} associated with the data input under test.
6. V_{CCO} = the V_{CC} associated with the output under test.
7. Don't care = any valid logic level.
8. Reflects current per supply, V_{CCA} or V_{CCB}.

AC Electrical Characteristics

Symbol	Parameter	T _A = -40 to +85°C										Unit
		V _{CCB} =3.0 V to 3.6 V		V _{CCB} =2.3 V to 2.7 V		V _{CCB} =1.65 V to 1.95 V		V _{CCB} =1.4 V to 1.6 V		V _{CCB} =1.1 V to 1.3V		
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
V _{CCA} =3.0 V to 3.6 V												
t _{PLH} , t _{PHL}	Propagation Delay A to B	0.2	3.5	0.3	3.9	0.5	5.4	0.6	6.8	1.4	22.0	ns
	Propagation Delay B to A	0.2	3.5	0.2	3.8	0.3	4.0	0.5	4.3	0.8	13.0	
t _{PZH} , t _{PZL}	Output Enable /OE to B	0.5	4.0	0.7	4.4	1.0	5.9	1.0	6.4	1.5	17.0	ns
	Output Enable /OE to A	0.5	4.0	0.5	4.0	0.5	4.0	0.5	4.0	0.5	4.0	
t _{PHZ} , t _{PLZ}	Output Disable /OE to B	0.2	3.8	0.2	4.0	0.7	4.8	1.5	6.2	2.0	17.0	ns
	Output Disable /OE to A	0.2	3.7	0.2	3.7	0.2	3.7	0.2	3.7	0.2	3.7	
V _{CCA} =2.3 V to 2.7 V												
t _{PLH} , t _{PHL}	Propagation Delay A to B	0.2	3.8	0.4	4.2	0.5	5.6	0.8	6.9	1.4	22.0	ns
	Propagation Delay B to A	0.3	3.9	0.4	4.2	0.5	4.5	0.5	4.8	1.0	7.0	
t _{PZH} , t _{PZL}	Output Enable /OE to B	0.6	4.2	0.8	4.6	1.0	6.0	1.0	6.8	1.5	17.0	ns
	Output Enable /OE to A	0.6	4.5	0.6	4.5	0.6	4.5	0.6	4.5	0.6	4.5	
t _{PHZ} , t _{PLZ}	Output Disable /OE to B	0.2	4.1	0.2	4.3	0.7	4.8	1.5	6.7	2.0	17.0	ns
	Output Disable /OE to A	0.2	4.0	0.2	4.0	0.2	4.0	0.2	4.0	0.2	4.0	
V _{CCA} =1.65 V to 1.95 V												
t _{PLH} , t _{PHL}	Propagation Delay A to B	0.3	4.0	0.5	4.5	0.8	5.7	0.9	7.1	1.5	22.0	ns
	Propagation Delay B to A	0.5	5.4	0.5	5.6	0.8	5.7	1.0	6.0	1.2	8.0	
t _{PZH} , t _{PZL}	Output Enable /OE to B	0.6	5.2	0.8	5.4	1.2	6.9	1.2	7.2	1.5	18.0	ns
	Output Enable /OE to A	1.0	6.7	1.0	6.7	1.0	6.7	1.0	6.7	1.0	6.7	
t _{PHZ} , t _{PLZ}	Output Disable /OE to B	0.2	5.1	0.2	5.2	0.8	5.2	1.5	7.0	2.0	17.0	ns
	Output Disable /OE to A	0.5	5.0	0.5	5.0	0.5	5.0	0.5	5.0	0.5	5.0	

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AC Electrical Characteristics

Symbol	Parameter	T _A = -40 to +85°C										Unit
		V _{CCB} =3.0 V to 3.6 V		V _{CCB} =2.3 V to 2.7 V		V _{CCB} =1.65 V to 1.95 V		V _{CCB} =1.4 V to 1.6 V		V _{CCB} =1.1 V to 1.3V		
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
V _{CCA} =1.4 V to 1.6 V												
t _{PLH} , t _{PHL}	Propagation Delay A to B	0.5	4.3	0.5	4.8	1.0	6.0	1.0	7.3	1.5	22.0	ns
	Propagation Delay B to A	0.6	6.8	0.8	6.9	0.9	7.1	1.0	7.3	1.3	9.5	
t _{PZH} , t _{PZL}	Output Enable /OE to B	1.1	7.5	1.1	7.6	1.3	7.7	1.4	7.9	2.0	20.0	ns
	Output Enable /OE to A	1.0	7.5	1.0	7.5	1.0	7.5	1.0	7.5	1.0	7.5	
t _{PHZ} , t _{PLZ}	Output Disable /OE to B	0.4	6.1	0.4	6.2	0.9	6.2	1.5	7.5	2.0	18.0	ns
	Output Disable /OE to A	1.0	6.0	1.0	6.0	1.0	6.0	1.0	6.0	1.0	6.0	
V _{CCA} =1.1 V to 1.3 V												
t _{PLH} , t _{PHL}	Propagation Delay A to B	0.8	13.0	1.0	7.0	1.2	8.0	1.3	9.5	2.0	24.0	ns
	Propagation Delay B to A	1.4	22.0	1.4	22.0	1.5	22.0	1.5	22.0	2.0	24.0	
t _{PZH} , t _{PZL}	Output Enable /OE to B	1.0	12.0	1.0	9.0	2.0	10.0	2.0	11.0	2.0	24.0	ns
	Output Enable /OE to A	2.0	22.0	2.0	22.0	2.0	22.0	2.0	22.0	2.0	22.0	
t _{PHZ} , t _{PLZ}	Output Disable /OE to B	1.0	15.0	0.7	7.0	1.0	8.0	2.0	10.0	2.0	20.0	ns
	Output Disable /OE to A	2.0	15.0	2.0	12.0	2.0	12.0	2.0	12.0	2.0	12.0	

Capacitance

Symbol	Parameter	Conditions	$T_A=+25^\circ\text{C}$	Unit
			Typical	
C_{IN}	Input Capacitance (Pins O/E, TR)	$V_{CCA}=V_{CCB}=3.3\text{ V}$, $V_I=0\text{ V}$ or $V_{CCA/B}$	4	pF
$C_{I/O}$	Input / Output Capacitance A_n , B_n Ports	$V_{CCA}=V_{CCB}=3.3\text{ V}$, $V_I=0\text{ V}$ or $V_{CCA/B}$	5	pF
C_{PD}	Power Dissipation Capacitance	$V_{CCA}=V_{CCB}=3.3\text{ V}$, $V_I=0\text{ V}$ or V_{CC} , $f=10\text{ MHz}$	20	pF

Physical Dimensions

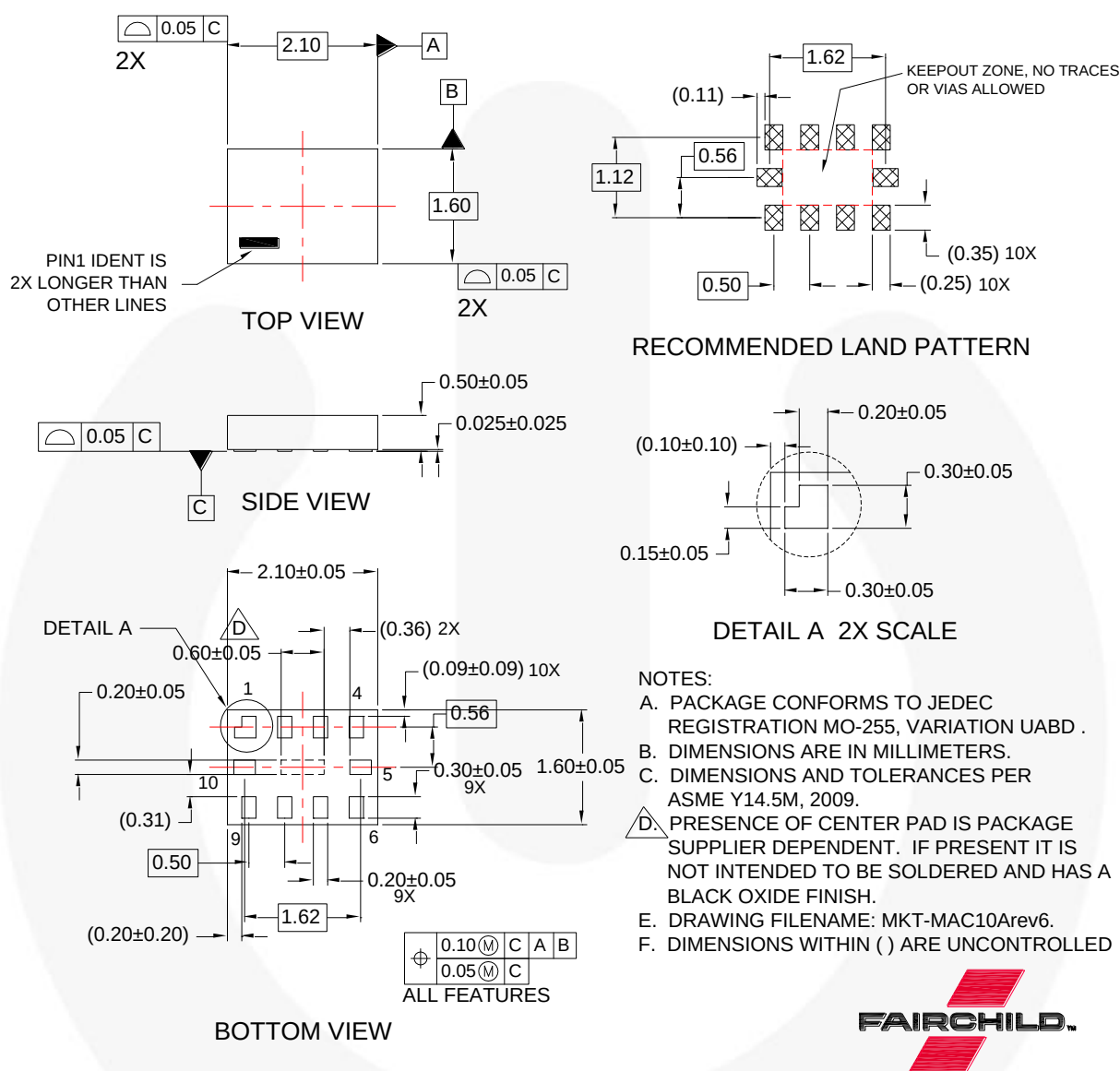


Figure 6. 10-Lead, MicroPak™, JEDEC MO255, 1.6 x 2.1 mm

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